Ignition IGBT, 20 A, 400 V

N–Channel DPAK

This Logic Level Insulated Gate Bipolar Transistor (IGBT) features monolithic circuitry integrating ESD and Over–Voltage clamped protection for use in inductive coil drivers applications. Primary uses include Ignition, Direct Fuel Injection, or wherever high voltage and high current switching is required.

Features

- Ideal for Coil-on-Plug Applications
- DPAK Package Offers Smaller Footprint for Increased Board Space
- Gate–Emitter ESD Protection
- Temperature Compensated Gate–Collector Voltage Clamp Limits Stress Applied to Load
- Integrated ESD Diode Protection
- New Design Increases Unclamped Inductive Switching (UIS) Energy Per Area
- Low Threshold Voltage Interfaces Power Loads to Logic or Microprocessor Devices
- Low Saturation Voltage
- High Pulsed Current Capability
- Emitter Ballasting for Short-Circuit Capability
- These are Pb–Free Devices

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

| Rating | Symbol | Value | Unit |
|--|-----------------------------------|----------------|------------------------------------|
| Collector-Emitter Voltage | V _{CES} | 430 | V _{DC} |
| Collector–Gate Voltage | V_{CER} | 430 | V _{DC} |
| Gate-Emitter Voltage | V_{GE} | 18 | V _{DC} |
| Collector Current–Continuous @ T _C = 25°C – Pulsed | Ι _C | 15 50 | A _{DC} A _{AC} |
| ESD (Human Body Model) R = 1500 Ω, C = 100 pF | ESD | 8.0 | kV |
| ESD (Machine Model) $R = 0 \Omega$, $C = 200 pF$ | ESD | 800 | V |
| Total Power Dissipation @ T _C = 25°C Derate above 25°C | P _D | 115 0.77 | Watts W/°C |
| Operating and Storage Temperature Range | T _J , T _{stg} | –55 to +175 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

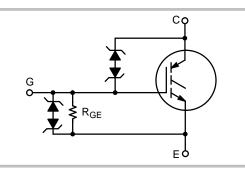


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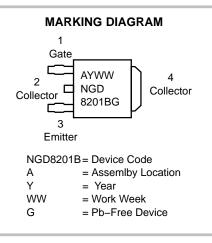
www.onsemi.com

20 AMPS, 400 VOLTS

V_{CE(on)} ≤ 1.8 V @ I_C = 10 A, V_{GE} ≥ 4.5 V







ORDERING INFORMATION

| Device | Package | Shipping [†] |
|--------------|-------------------|-----------------------|
| NGD8201BNT4G | DPAK (Pb–Free) | 2500/Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

UNCLAMPED COLLECTOR-TO-EMITTER AVALANCHE CHARACTERISTICS ($-55^{\circ} \le T_J \le 175^{\circ}C$)

| Characteristic | Symbol | Value | Unit |
|--|--------------------|-------------------|------|
| $ Single Pulse Collector-to-Emitter Avalanche Energy \\ V_{CC} = 50 \text{ V}, V_{GE} = 5.0 \text{ V}, \text{ Pk } \text{I}_{\text{L}} = 22 \text{ A}, \text{R}_{\text{G}} = 1000 \ \Omega, \text{ L} = 1.8 \text{ mH}, \text{Starting } \text{T}_{\text{J}} = 25^{\circ}\text{C} \\ V_{CC} = 50 \text{ V}, \text{V}_{\text{GE}} = 5.0 \text{ V}, \text{ Pk } \text{I}_{\text{L}} = 17 \text{ A}, \text{R}_{\text{G}} = 1000 \ \Omega, \text{ L} = 3.0 \text{ mH}, \text{Starting } \text{T}_{\text{J}} = 25^{\circ}\text{C} \\ \text$ | E _{AS} | 435 433 325 | mJ |
| Reverse Avalanche Energy V _{CC} = 100 V, V _{GE} = 20 V, Pk I _L = 25.8 A, L = 6.0 mH, Starting T _J = 25°C | E _{AS(R)} | 2000 | mJ |

THERMAL CHARACTERISTICS

| Thermal Resistance, Junction to Case | | $R_{	extsf{	heta}JC}$ | 1.3 | °C/W |
|---|---------------|-----------------------|-----|------|
| Thermal Resistance, Junction to Ambient | DPAK (Note 1) | $R_{	heta JA}$ | 95 | °C/W |
| Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds | | TL | 275 | °C |

1. When surface mounted to an FR4 board using the minimum recommended pad size.

ELECTRICAL CHARACTERISTICS

| Characteristic | Symbol | Test Conditions | Temperature | Min | Тур | Max | Unit |
|---|----------------------|---|------------------------------------|-----|-----|-----|------------------|
| OFF CHARACTERISTICS | | | | | | | - |
| Collector-Emitter Clamp Voltage | BV _{CES} | I _C = 2.0 mA | $T_J = -40^{\circ}C$ to 150°C | 380 | 395 | 420 | V _{DC} |
| | | I _C = 10 mA | $T_J = -40^{\circ}C$ to 150°C | 390 | 405 | 430 | |
| Zero Gate Voltage Collector Current | I _{CES} | | T _J = 25°C | - | 1.5 | 5 | μA_{DC} |
| | | V _{CE} = 350 V, V _{GF} = 0 V | T _J = 150°C | - | 10 | 30* | |
| | | VGE - O V | $T_J = -40^{\circ}C$ | - | 0.5 | 2.5 | |
| | | V _{CE} = 15 V, V _{GE} = 0 V | T _J = 25°C | - | _ | 2.0 |) |
| Reverse Collector-Emitter Leakage Current | I _{ECS} | | T _J = 25°C | - | 0.7 | 1.0 | mA |
| | | $V_{CE} = -24 V$ | T _J = 150°C | - | 12 | 25* | |
| | | | $T_J = -40^{\circ}C$ | - | 0.1 | 1.0 | |
| Reverse Collector-Emitter Clamp Voltage | B _{VCES(R)} | | $T_J = 25^{\circ}C$ | 27 | 33 | 37 | V _{DC} |
| | | I _C = -75 mA | $T_J = 150^{\circ}C$ | 30 | 36 | 40 | |
| | | | $T_J = -40^{\circ}C$ | 25 | 32 | 35 | |
| Gate-Emitter Clamp Voltage | BV _{GES} | I _G = 5.0 mA | $T_J = -40^{\circ}C$ to 150°C | 11 | 13 | 15 | V _{DC} |
| Gate-Emitter Leakage Current | I _{GES} | V _{GE} = 10 V | $T_J = -40^{\circ}C$ to 150°C | 384 | 640 | 700 | μA _{DC} |
| Gate Emitter Resistor (Note 3) | R _{GE} | _ | T _J = -40°C to 150°C | 10 | 16 | 26 | kΩ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. *Maximum Value of Characteristic across Temperature Range.

ELECTRICAL CHARACTERISTICS (continued)

| Characteristic | Symbol | Test Conditions | Temperature | Min | Тур | Max | Unit |
|--|---------------------|---|--|-----|-----|------|-----------------|
| ON CHARACTERISTICS (Note 2) | | | | | | | |
| Gate Threshold Voltage | V _{GE(th)} | | $T_J = 25^{\circ}C$ | 1.2 | 1.5 | 1.8 | V _{DC} |
| | | I _C = 1.0 mA, V _{GE} = V _{CE} | T _J = 150°C | 0.8 | 1.0 | 1.3 | |
| | | | $T_J = -40^{\circ}C$ | 1.4 | 1.7 | 2.0* | |
| Threshold Temperature Coefficient (Negative) | - | - | - | - | 3.4 | - | mV/°C |
| Collector-to-Emitter On-Voltage | V _{CE(on)} | | T _J = 25°C | 1.0 | 1.2 | 1.5 | V _{DC} |
| | | I _C = 6.0 A, V _{GE} = 4.0 V | T _J = 150°C | 1.0 | 1.2 | 1.5 | |
| | | | $T_J = -40^{\circ}C$ | 1.0 | 1.2 | 1.5* | 1 |
| | | | $T_J = 25^{\circ}C$ | 1.2 | 1.4 | 1.6* | 1 |
| | | I _C = 8.0 A, V _{GE} = 4.0 V | $T_J = 150^{\circ}C$ | 1.2 | 1.4 | 1.6 | 1 |
| | | GE NO T | $T_J = -40^{\circ}C$ | 1.2 | 1.4 | 1.6* | 1 |
| | | | $T_J = 25^{\circ}C$ | 1.3 | 1.5 | 1.8 | |
| | | I _C = 10 A, V _{GE} = 4.0 V | $T_J = 150^{\circ}C$ | 1.3 | 1.5 | 1.9 | |
| | | GE NO | $T_J = -40^{\circ}C$ | 1.3 | 1.6 | 1.8* | |
| | | | $T_J = 25^{\circ}C$ | 1.7 | 1.9 | 2.3 | |
| | | I _C = 15 A, V _{GE} = 4.0 V | $T_J = 150^{\circ}C$ | 1.9 | 2.2 | 2.5* | |
| | | | $T_J = -40^{\circ}C$ | 1.5 | 1.9 | 2.3 | |
| | | | $T_J = 25^{\circ}C$ | 1.3 | 1.5 | 1.8* | |
| | | I _C = 10 A, V _{GE} = 4.5 V | $T_J = 150^{\circ}C$ | 1.3 | 1.5 | 1.8* | |
| | | GE NO | $T_J = -40^{\circ}C$ | 1.3 | 1.5 | 1.8* | |
| | | I _C = 6.5 A, V _{GE} = 3.7 V | T _J = 25°C | - | - | 1.65 | |
| Forward Transconductance | gfs | V_{CE} = 5.0 V, I _C = 6.0 A | $T_J = -40^{\circ}C$ to $150^{\circ}C$ | 8.0 | 14 | 25 | Mhos |
| YNAMIC CHARACTERISTICS (Note | e 3) | | | | | | |
| Input Capacitance | Ciec | | | 400 | 800 | 1000 | nF |

| Input Capacitance | C _{ISS} | | | 400 | 800 | 1000 | pF | |
|----------------------|------------------|--|------------------------------------|-----|-----|------|----|--|
| Output Capacitance | C _{OSS} | V _{CC} = 25 V, V _{GE} = 0 V f = 1.0 MHz | T _J = −40°C to 150°C | 50 | 75 | 100 | | |
| Transfer Capacitance | C _{RSS} | | | 4.0 | 7.0 | 10 | | |

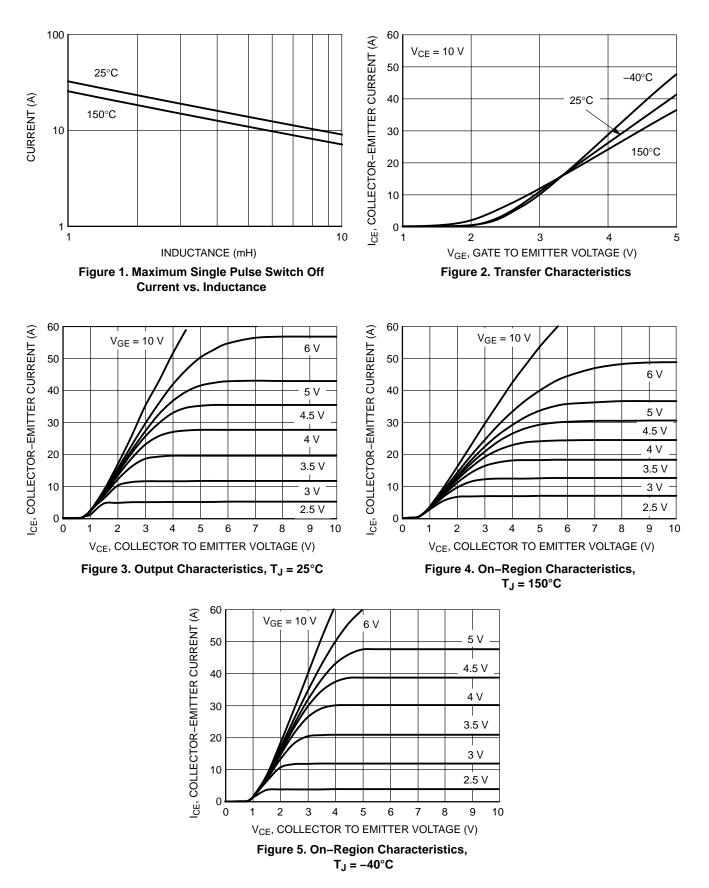
SWITCHING CHARACTERISTICS (Note 3)

| Turn–Off Delay Time (Resistive) | t _{d(off)} | | $T_J = 25^{\circ}C$ | - | 4.0 | 10 | μSec |
|---------------------------------|---------------------|--|---------------------|---|-----|-----|------|
| Fall Time (Resistive) | t _f | | $T_J = 25^{\circ}C$ | - | 9.0 | 15 | |
| Turn–On Delay Time | t _{d(on)} | $V_{CC} = 10 \text{ V}, \text{ I}_{C} = 6.5 \text{ A} \\ \text{R}_{G} = 1.0 \text{ k}\Omega, \text{ R}_{L} = 1.5 \Omega$ | $T_J = 25^{\circ}C$ | - | 0.7 | 4.0 | μSec |
| Rise Time | t _r | $V_{CC} = 10 \text{ V}, \text{ I}_{C} = 6.5 \text{ A}$ $\text{R}_{G} = 1.0 \text{ k}\Omega, \text{ R}_{L} = 1.5 \Omega$ | $T_J = 25^{\circ}C$ | - | 4.5 | 7.0 | |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. *Maximum Value of Characteristic across Temperature Range. 2. Pulse Test: Pulse Width \leq 300 µS, Duty Cycle \leq 2%.

3. Not production tested.

TYPICAL ELECTRICAL CHARACTERISTICS



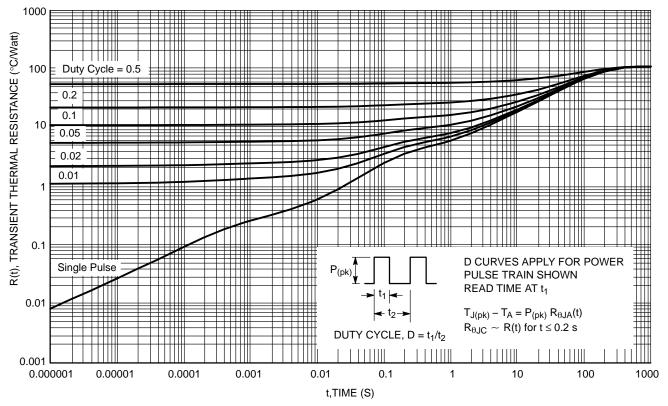
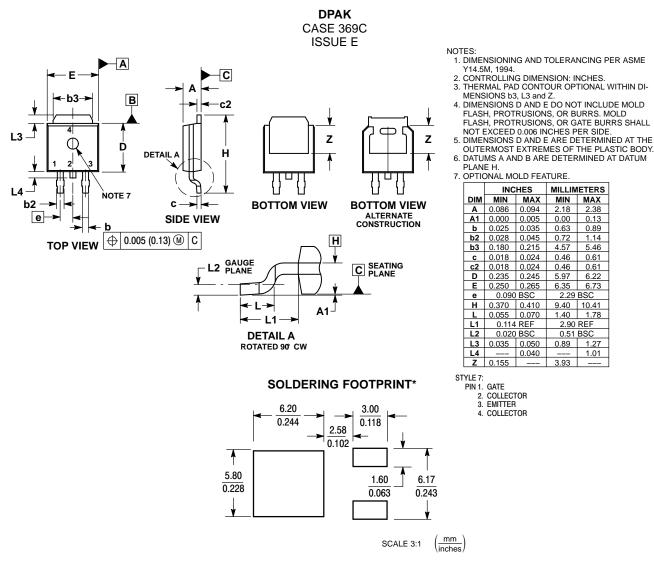


Figure 6. Transient Thermal Resistance (Non-normalized Junction-to-Ambient mounted on minimum pad area)

PACKAGE DIMENSIONS



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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